APT3216SECK
3.2 mm x 1.6 mm SMD Chip LED Lamp

DESCRIPTIONS
- The Super Bright Orange device is made with AlGaInP (on GaAs substrate) light emitting diode chip
- Electrostatic discharge and power surge could damage the LEDs
- It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs
- All devices, equipments and machineries must be electrically grounded

FEATURES
- 3.2 mm x 1.6 mm SMD LED, 0.75 mm thickness
- Low power consumption
- Wide viewing angle
- Ideal for backlight and indicator
- Package: 2000 pcs / reel
- Moisture sensitivity level: 3
- Halogen-free
- RoHS compliant

APPLICATIONS
- Backlight
- Status indicator
- Home and smart appliances
- Wearable and portable devices
- Healthcare applications

ATTENTION
Observe precautions for handling electrostatic discharge sensitive devices

PACKAGE DIMENSIONS

RECOMMENDED SOLDERING PATTERN
(units : mm; tolerance : ± 0.1)

SELECTED SOLDERING PATTERN

<table>
<thead>
<tr>
<th>Part Number</th>
<th>Emitting Color (Material)</th>
<th>Lens Type</th>
<th>Iv (mcd) @ 20mA [2]</th>
<th>Viewing Angle [1]</th>
</tr>
</thead>
<tbody>
<tr>
<td>APT3216SECK</td>
<td>Super Bright Orange (AlGaInP)</td>
<td>Water Clear</td>
<td>120, 250</td>
<td>140°</td>
</tr>
</tbody>
</table>

Notes:
1. θ1/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.
2. Luminous intensity / luminous flux: ±15%.
3. The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.
4. The device has a single mounting surface. The device must be mounted according to the specifications.

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### ELECTRICAL / OPTICAL CHARACTERISTICS at $T_A=25^\circ C$

<table>
<thead>
<tr>
<th>Parameter</th>
<th>Symbol</th>
<th>Emitting Color</th>
<th>Value</th>
<th>Unit</th>
</tr>
</thead>
<tbody>
<tr>
<td>Wavelength at Peak Emission $I_F = 20mA$</td>
<td>$\lambda_{\text{peak}}$</td>
<td>Super Bright Orange</td>
<td>610</td>
<td>nm</td>
</tr>
<tr>
<td>Dominant Wavelength $I_F = 20mA$</td>
<td>$\lambda_{\text{dom}}$</td>
<td>Super Bright Orange</td>
<td>605</td>
<td>nm</td>
</tr>
<tr>
<td>Spectral Bandwidth at 50% $\Phi_{\text{REL MAX}}$ $I_F = 20mA$</td>
<td>$\Delta \lambda$</td>
<td>Super Bright Orange</td>
<td>29</td>
<td>nm</td>
</tr>
<tr>
<td>Capacitance</td>
<td>$C$</td>
<td>Super Bright Orange</td>
<td>15</td>
<td>pF</td>
</tr>
<tr>
<td>Forward Voltage $I_F = 20mA$</td>
<td>$V_F$</td>
<td>Super Bright Orange</td>
<td>2.1</td>
<td>V</td>
</tr>
<tr>
<td>Reverse Current ($V_F=5V$)</td>
<td>$I_R$</td>
<td>Super Bright Orange</td>
<td>-</td>
<td>10 $\mu A$</td>
</tr>
<tr>
<td>Temperature Coefficient of $\lambda_{\text{peak}}$ $I_F = 20mA, -10^\circ C \leq T \leq 85^\circ C$</td>
<td>$T_{C_{\lambda_{\text{peak}}}}$</td>
<td>Super Bright Orange</td>
<td>0.13</td>
<td>nm/°C</td>
</tr>
<tr>
<td>Temperature Coefficient of $\lambda_{\text{dom}}$ $I_F = 20mA, -10^\circ C \leq T \leq 85^\circ C$</td>
<td>$T_{C_{\lambda_{\text{dom}}}}$</td>
<td>Super Bright Orange</td>
<td>0.06</td>
<td>nm/°C</td>
</tr>
<tr>
<td>Temperature Coefficient of $V_F$ $I_F = 20mA, -10^\circ C \leq T \leq 85^\circ C$</td>
<td>$T_{C_{V}}$</td>
<td>Super Bright Orange</td>
<td>-1.9</td>
<td>mV/°C</td>
</tr>
</tbody>
</table>

### ABSOLUTE MAXIMUM RATINGS at $T_A=25^\circ C$

<table>
<thead>
<tr>
<th>Parameter</th>
<th>Symbol</th>
<th>Value</th>
<th>Unit</th>
</tr>
</thead>
<tbody>
<tr>
<td>Power Dissipation</td>
<td>$P_D$</td>
<td>75</td>
<td>mW</td>
</tr>
<tr>
<td>Reverse Voltage</td>
<td>$V_R$</td>
<td>5</td>
<td>V</td>
</tr>
<tr>
<td>Junction Temperature</td>
<td>$T_J$</td>
<td>115</td>
<td>°C</td>
</tr>
<tr>
<td>Operating Temperature</td>
<td>$T_{\text{op}}$</td>
<td>-40 to +85</td>
<td>°C</td>
</tr>
<tr>
<td>Storage Temperature</td>
<td>$T_{\text{slg}}$</td>
<td>-40 to +85</td>
<td>°C</td>
</tr>
<tr>
<td>DC Forward Current</td>
<td>$I_F$</td>
<td>30</td>
<td>mA</td>
</tr>
<tr>
<td>Peak Forward Current</td>
<td>$I_{F\text{M}}$</td>
<td>195</td>
<td>mA</td>
</tr>
<tr>
<td>Electrostatic Discharge Threshold (HBM)</td>
<td>-</td>
<td>3000</td>
<td>V</td>
</tr>
<tr>
<td>Thermal Resistance (Junction / Ambient)</td>
<td>$R_{\text{th JA}}$</td>
<td>750</td>
<td>°C/W</td>
</tr>
<tr>
<td>Thermal Resistance (Junction / Solder point)</td>
<td>$R_{\text{th JS}}$</td>
<td>560</td>
<td>°C/W</td>
</tr>
</tbody>
</table>

**Notes:**
1. The dominant wavelength ($\lambda_{\text{d}}$) above is the setup value of the sorting machine. (Tolerance $\lambda_{\text{d}} : \pm 1\text{nm}$.)
2. Forward voltage: ≤ 1V.
3. Wavelength value is traceable to CIE127-2007 standards.
4. Excess driving current and/or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

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**Notes:**
1. 1/10 Duty Cycle, 0.1ms Pulse Width.
2. $R_{\text{th JA}}, R_{\text{th JS}}$: Results from mounting on PC board FR4 (pad size ≥ 16 mm$^2$ per pad).
3. Relative humidity levels maintained between 40% and 60% in production area are recommended to avoid the build-up of static electricity – Ref JEDEC/JESD625-A and JEDEC/J-STD-033.
TECHNICAL DATA

RELATIVE INTENSITY vs. WAVELENGTH

Forward Current vs. Forward Voltage

Luminous Intensity vs. Forward Current

Forward Current Derating Curve

Luminous Intensity vs. Ambient Temperature

SUPER BRIGHT ORANGE

Forward Current vs. Forward Voltage

Luminous Intensity vs. Forward Current

Forward Current Derating Curve

Luminous Intensity vs. Ambient Temperature

REFLOW SOLDERING PROFILE for LEAD-FREE SMD PROCESS

TAPE SPECIFICATIONS (units : mm)

REEL DIMENSION (units : mm)

Notes:
1. Don't cause stress to the LEDs while it is exposed to high temperature.
2. The maximum number of reflow soldering passes is 2 times.
3. Reflow soldering is recommended. Other soldering methods are not recommended as they might cause damage to the product.
PACKING & LABEL SPECIFICATIONS

User Direction of Feed

Label

2,000pcs / Reel

1 Reel / Bag

30K / Box

60K / Box

PRECAUTIONARY NOTES

1. The information included in this document reflects representative usage scenarios and is intended for technical reference only.
2. The part number, type, and specifications mentioned in this document are subject to future change and improvement without notice. Before production usage customer should refer to the latest datasheet for the updated specifications.
3. When using the products referenced in this document, please make sure the product is being operated within the environmental and electrical limits specified in the datasheet. If customer usage exceeds the specified limits, Kingbright will not be responsible for any subsequent issues.
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